

Section 2. Forms PTO/SB/08A and 08B (formerly Form PTO-1449)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Tabrizi, Behnam Attorney Docket: 1920/107
 Serial No: 09/677,291 Art Group Unit: 2812
 Date Filed: October 2, 2000 Examiner Name: Not Yet Assigned
 Invention: Semiconductor Packaging



**LIST OF PATENTS AND PUBLICATIONS FOR
 APPLICANT'S INFORMATION DISCLOSURE STATEMENT**

United States Patents

Examiner Initials	Reference Number	Document Number	Issue Date	Inventor	Class/Subclass
<u>C. C.</u>	AA	4,745,455	05/17/88	Glascock et al.	357/74
<u>C. C.</u>	AB	5,034,044	07/23/91	Glascock	65/42
<u>C. C.</u>	AC	5,133,795	07/28/92	Glascock	65/42
<u>C. C.</u>	AD	5,424,573	06/13/95	Kato et al.	257/431
<u>C. C.</u>	AE	5,610,442	03/11/97	Schneider et al.	257/787
<u>C. C.</u>	AF	5,801,073	09/01/98	Robbins et al.	438/125
<u>C. C.</u>	AG	5,863,812	01/26/99	Manteghi	438/108
<u>C. C.</u>	AH	5,877,478	03/02/99	Ando	257/777
<u>C. C.</u>	AI	6,013,948	01/11/00	Akram	257/698

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Other Documents

Examiner Initials	Reference Number	Author	Title of Article, Title of Journal, Volume Number, Page Numbers, Date
<u>C. C.</u>	AJ	Francis et al.	"Stackable 3-D Chip-Scale Package Uses Silicon as the Substrate", Chip Scale Review, vol. 1, No. 1, p.79, May 1997.

C.C.

AK

Savastiouk et
al.

"3-D Stacked Wafer-Level Packaging", Advanced
Packaging Magazine, Cover Story, March 2000.

Examiner Signature: _____

Date Considered: _____

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation *if not* in conformance and not considered. Include copy of this form with next communication to applicant.

01920/00107 145532.1



SECTION 2: FORM PTO 1449 - MODIFIED

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Tabrizi, B. Atty Dkt: 1920/107
Serial No: 09/677,291 Date: June 20, 2001
Date Filed: October 2, 2000
Invention: Semiconductor Packaging

Commissioner for Patents
Washington, DC 20231

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANTS'
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

U.S. Documents

Exam. Ref. <u>Init.</u> <u>No.</u>	Document <u>Number</u>	Issue <u>Date</u>	<u>Name</u>	<u>Class</u>
C. C. AL	3,436,604	4/1/69	Luecke, et al.	317/101
C. C. AM	4,936,808	6/26/90	Lee	445/24
C. C. AN	5,198,963	3/30/93	Gupta, et al.	361/386

Foreign Patent Documents

Exam. Ref. <u>Init.</u> <u>No.</u>	Document <u>Number</u>	Issue <u>Date</u>	<u>Name</u>
C. C. AO	WO 96/12298	4/25/96	Hsue, et al.
C. C. AP	WO 99/28971	6/10/99	Preuss, et al.

Other Documents

C.C. AQ EPO International Search Report; PCT/US 00/27206; 10/2/00
Examiner: *Andrew H. H. H.*

Date Considered: *Oct. 15, 2001*

NOTE FOR EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance AND not considered. Include copy of this form with next communication to applicant.